



IPSR-INTERNATIONAL LAUNCH
SPECIAL TECHNICAL AND ORGANIZATIONAL MEETING
9:00 AM-5:00 PM, Wednesday, November 28, 2018
MIT, Cambridge, MA

WHO SHOULD ATTEND? *Current IPSR and World Technology Roadmap Forum TWG members.*

PURPOSE: *IPSR-International brings together the EU, US and Asian Roadmap efforts under a single governance and reporting structure. Members of Technical Working Groups (TWGs) from these constituencies will meet on Wednesday, November 28th to formally merge their TWGs and documents. The initial structure for the global governance of the organization will be formulated at the end of the day.*

WEDNESDAY, NOVEMBER 28 IPSR-INTERNATIONAL TWG MERGERS

SESSION 1: INTRODUCTION TO IPSR-INTERNATIONAL ROADMAP AND COMMUNITY

SESSION 2: TWG BREAKOUTS

- MONOLITHIC SILICON INTEGRATION, INDIUM PHOSPHIDE & 3-5 COMPOUNDS, E-P PACKAGING, E-P INTERCONNECT, E-P CONNECTORS, E-P ASSEMBLY, E-P TEST, E-P SENSORS, E-P DESIGN AUTOMATION

SESSION 3: CROSS-CUTTING TWG BREAKOUTS

- DEVICE SYSTEMS TWGs
- INTERCONNECT TWGs

SESSION 4: CROSS-CUTTING TWG BREAKOUTS

- DEVICE TECHNOLOGY TWGs
- SYSTEM TWGs

SESSION 5: REPORT BACK FROM SESSIONS 3-4

SESSION 6: IPSR-INTERNATIONAL GOVERNANCE STRUCTURE